

TRANSMITTAL

Electronic Version v1.1

Stylesheet Version v1.1.0

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| Title of Invention | [STRUCTURE OF THIN-FILM TRANSISTOR AND METHOD AND EQUIPMENT FOR FABRICATING THE STRUCTURE] | | | | | | | |
| Application Number : | | | | | | | | |
| Date : | | | | | | | | |
| First Named Applicant: | Mr. Wen-Chang Yeh | | | | | | | |
| Confirmation Number: | | | | | | | | |
| Attorney Docket Number: | 11340-US-PA | | | | | | | |
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| <table border="1"><tr><td>Submitted By:</td><td>Elec. Sign.</td><td>Sign. Capacity</td></tr><tr><td>Dr. Belinda Lee Registered Number: 46,863</td><td>/Belinda Lee/</td><td>Agent</td></tr></table> | | | Submitted By: | Elec. Sign. | Sign. Capacity | Dr. Belinda Lee Registered Number: 46,863 | /Belinda Lee/ | Agent |
| Submitted By: | Elec. Sign. | Sign. Capacity | | | | | | |
| Dr. Belinda Lee Registered Number: 46,863 | /Belinda Lee/ | Agent | | | | | | |

| Documents being submitted: | Files |
|----------------------------|---|
| us-request | 11340-usrequ.xml us-request.dtd us-request.xsl |
| us-fee-sheet | 11340-usfees.xml us-fee-sheet.xsl us-fee-sheet.dtd |
| application-body | 11340-trans.xml us-application-body.xsl application-body.dtd wipo.ent mathml2.dtd mathml2-qname-1.mod isoamsa.ent isoamsb.ent isoamsc.ent isoamsn.ent isoamso.ent isoamsr.ent isogr3.ent isomfrk.ent isomopf.ent isomscr.ent isotech.ent isobox.ent isocyr1.ent isocyr2.ent isodia.ent isolat1.ent isolat2.ent isonum.ent isopub.ent mmlextra.ent mmlalias.ent soextblx.dtd 11340US0001.tif 11340US0002.tif 11340US0003.tif 11340US0004.tif 11340US0005.tif 11340US0006.tif 11340US0007.tif 11340US0008.tif 11340US0009.tif 11340US0010.tif 11340US0011.tif 11340US0012.tif 11340US0013.tif 11340US0014.tif 11340US0015.tif |

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| | 11340US0022.tif |
| | 11340US0023.tif |
| us-declaration | 11340declaration01.tif |
| us-declaration | 11340declaration02.tif |
| Comments | |
| <p>Please be kindly advised that the indicated fees of this EFS application is intended to be paid by credit card. However, in the event that the payment through credit card is unsuccessful, the Commissioner is authorized to charge the required fees in connection with this application to: Deposit Account No. 50-2620 (Order No. 11340-US-PA), Deposit Account Name: Jianq Chyun Intellectual Property Office, Authorized User Name: Belinda Lee, E-mail: belinda@jcipgroup.com.tw; usa@jcipgroup.com.tw</p> | |